

New Product

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)		
-20	0.032 @ V _{GS} = -4.5 V	-7.1			
	0.040 @ V _{GS} = -2.5 V	-6.4	16.5		
	0.053 @ V _{GS} = -1.8 V	-5.5			

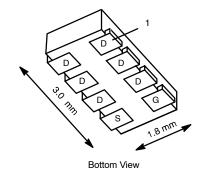
FEATURES

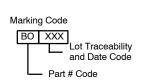
- TrenchFET® Power MOSFET
- Ultra-Low On-Resistance
- Thermally Enhanced ChipFET® Package
- 40% Smaller Footprint Than TSOP-6

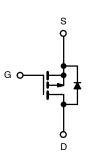
APPLICATIONS

 Load Switch, PA Switch, and Battery Switch for Portable Devices

1206-8 ChipFET®







P-Channel MOSFET

Ordering Information: Si5401DC-T1—E3

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	5 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-20		V	
Gate-Source Voltage		V _{GS}	±8			
Continuous Dusin Courset /T 150°0\8	T _A = 25°C	. I _D	-7.1	-5.2	A	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 85°C		-5.1	-3.7		
Pulsed Drain Current		I _{DM}	-20		^	
Continuous Source Current ^a		I _S	-2.1 -1.1			
Mandanian Davida Dissipation	T _A = 25°C		2.5	1.3	14/	
Maximum Power Dissipation ^a	T _A = 85°C	- P _D	1.3	0.7	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	
Soldering Recommendations (Peak Temperature)b, c			260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 5 sec	R _{thJA}	40	50		
Maximum Junction-to-Ambient ^a	Steady State		80	95	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	15	20		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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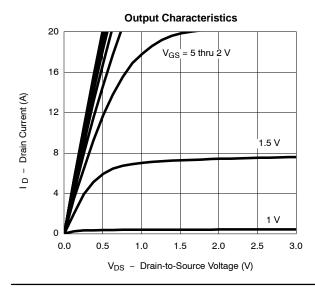


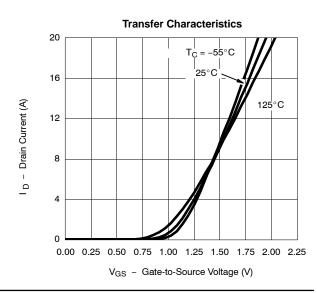
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.40		-1.0	V		
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±8 V			± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85^{\circ}\text{C}$			-1 -5	μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20			Α		
		$V_{GS} = -4.5 \text{ V}, \ I_D = -5.2 \text{ A}$		0.026	0.032			
Drain-Source On-State Resistancea	r _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -4.6 \text{ A}$		0.033	0.040	Ω		
		$V_{GS} = -1.8 \text{ V}, I_D = -1.9 \text{ A}$		0.044	0.053			
Forward Transconductancea	9fs	V _{DS} = -10 V, I _D = -5.2 A		20		S		
Diode Forward Voltage ^a	V _{SD}	$I_S = -1.1 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V		
Dynamic ^b								
Total Gate Charge	Qg			16.5	25	nC		
Gate-Source Charge	Q _{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -5.2 A		1.7				
Gate-Drain Charge	Q _{gd}			3.5				
Gate Resistance	R_{g}	f = 1 MHz		9		Ω		
Turn-On Delay Time	t _{d(on)}			10	15			
Rise Time	t _r	V _{DD} = -10 V. R _I = 10 Ω		25	40	ns		
Turn-Off Delay Time	t _{d(off)}	V_{DD} = -10 V, R_L = 10 Ω $I_D \cong -1$ A, V_{GEN} = -4.5 V, R_g = 6 Ω		115	175			
Fall Time	t _f			70	105			
Source-Drain Reverse Recovery Time	t _{rr}	1 1 1 A di/dt 100 A/:-		30	60			
Reverse Recovery Charge	Q _{rr}			140		nC		

- Notes a. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



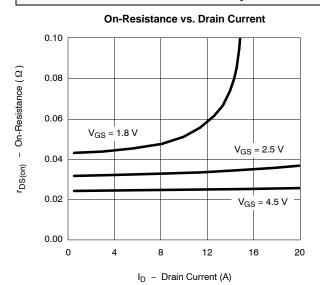




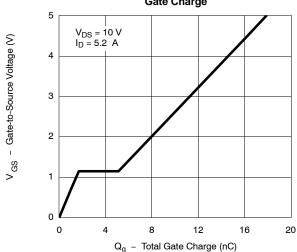


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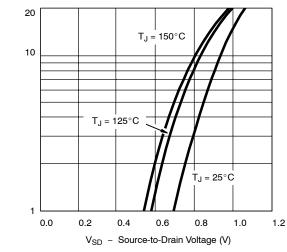
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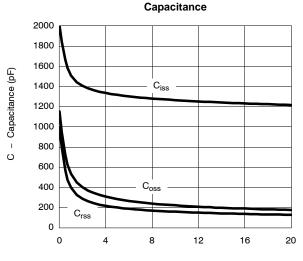






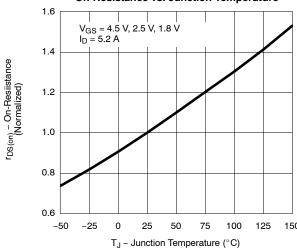
Source-Drain Diode Forward Voltage



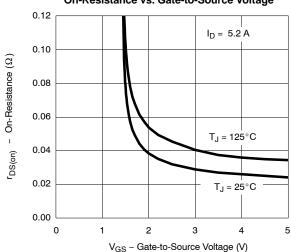


V_{DS} - Drain-to-Source Voltage (V)

On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



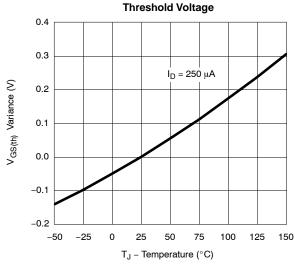
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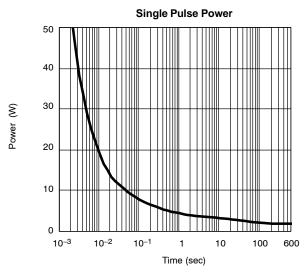
Source Current (A)

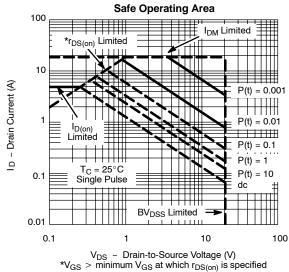
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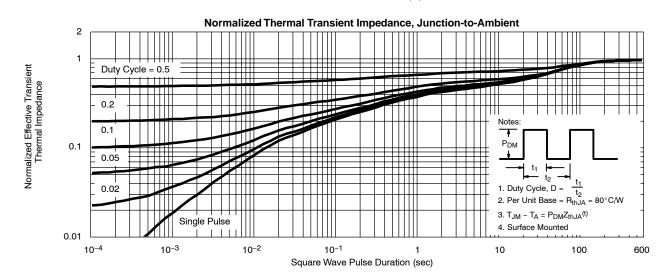


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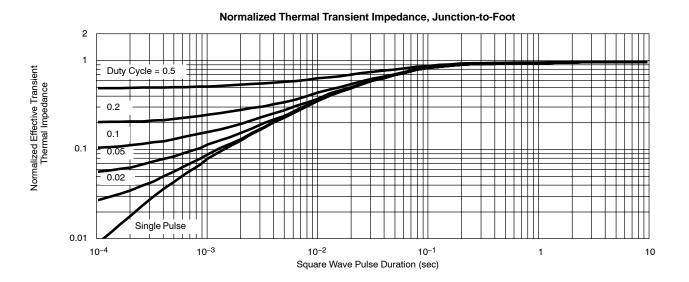






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TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73225.

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